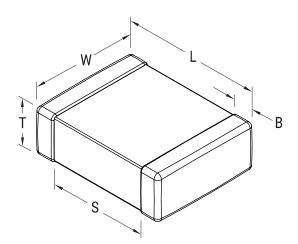


C1206X221J2GACTU

Aliases (C1206X221J2GAC7800) SMD Comm COG Flex, Ceramic, 220 pF, 5%, 200 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	15 mg
Shelf Life	78 Weeks
MSL	1

 Dimensions

 Chip Size
 1206

 L
 3.3mm +/-0.4mm

 W
 1.6mm +/-0.35mm

 T
 0.78mm +/-0.20mm

 S
 1.5mm MIN

 B
 0.6mm +/-0.25mm

Packaging Specifications

Packaging Packaging Quantity T&R, 180mm, Plastic Tape 4000

Specifications	
Capacitance	220 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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